

FORESEE eMMC FEMDNN032G-58A46 Datasheet

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Revision History:

| Rev. | Date | Changes | Remark |
|------|------------|-----------------------------|-------------|
| 1.0 | 2021/10/09 | Basic spec and architecture | Preliminary |
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CONTENTS

| 1. Introduction | 4 |
|---------------------------------|----|
| 2. Product List | 4 |
| 3. Features | 4 |
| 4. Functional Description | 5 |
| 5. Product Specifications | 6 |
| 5.1 Performance | 6 |
| 5.2 Power Consumption | 6 |
| 6. Pin Assignments | 7 |
| 6.1 Ball Array view | 7 |
| 6.2 Ball Array view | 8 |
| 7. Usage Overview | 9 |
| 7.1 General description | 9 |
| 7.2 Partition Management | 9 |
| 7.3 Automatic Sleep Mode | 11 |
| 7.4 Sleep (CMD5) | 11 |
| 7.5 H/W Reset operation | 12 |
| 7.6 High-speed mode selection | 12 |
| 7.7 Bus width selection | 12 |
| 7.8 Partition configuration | 12 |
| 7.9 CID register | 12 |
| 7.10 CSD register | 13 |
| 7.11 Extended CSD register | 14 |
| 7.12 OCR Register | 23 |
| 7.13 Field firmware update(FFU) | 23 |
| 7.14 S.M.A.R.T. Health Report | 25 |
| 8. Package Dimension | 26 |
| 9 Connection Guide | 26 |



| 9.1 Schematic Diagram | 26 |
|-----------------------|----|
| | |
| 10. Processing Guide | 27 |

1. Introduction

ISOCOM eMMC is an embedded storage solution designed in the BGA package. The ISOCOM eMMC consists of NAND flash and eMMC controller. The controller could manage the interface protocols, wear-leveling, bad block management and ECC.

ISOCOM eMMC has high performance at a competitive cost, high quality and low power consumption, and eMMC is compatible with JEDEC standard eMMC 5.1 specifications.

2. Product List

| Density | PartNumber | Capacity (MB) | Capacity (bytes) | User Density | Package Size(mm) | Package Type | Remark |
|---------|------------------|---------------|------------------|--------------|---------------------|-----------------|--------|
| 32GB | FEMDNN032G-58A46 | 29600 | 31037849600 | 90% | 11.5x13 | 153FBGA | 58A46 |

3. Features

eMMC5.1 specification compatibility

(Backward compatible to eMMC4.41/4.5/5.0)

- Bus mode
 - Data bus width: 1 bit (default), 4 bits, 8 bits
 - Data transfer rate: up to 400MB/s (HS400)
 - MMC I/F Clock frequency: 0~200MHz
- Operating voltage range
 - Vcc(NAND): 2.7 3.6V
 - Vccq(Controller): 1.7 1.95V / 2.7 3.6V
- > Temperature
 - Operation (-25° $\mathbb{C} \sim +85°\mathbb{C}$)
 - Storage without operation (-40°C ~ +85°C)
- Sudden-Power-Loss safeguard
- > Hardware ECC engine
- > Unique firmware backup mechanism

- Global-wear-leveling
- Supported features.
 - HS400, HS200
 - Partitioning, RPMB
 - Boot feature, boot partition
 - HW Reset/SW Reset
 - Discard, Trim, Erase, Sanitize
 - Background operations, HPI
 - Enhanced reliable write
 - S.M.A.R.T. Health Report
 - FFU
 - Sleep / awake
- Others
 - Compliance with the RoHS Directive



4. Functional Description

ISOCOM eMMC with powerful L2P (Logical to Physical) NAND Flash management algorithm provides unique functions:

- > Host independence from details of operating NAND flash
- > Internal ECC to correct defect in NAND flash
- Sudden-Power-Loss safeguard

To prevent from data loss, a mechanism named Sudden-Power-Loss safeguard is added in the eMMC. In the case of sudden power-failure, the eMMC would work properly after power cycling.

➤ Global-wear-leveling

To achieve the best stability and device endurance, this eMMC equips the Global Wear Leveling algorithm. It ensures that not only normal area, but also the frequently accessed area, such as FAT, would be programmed and erased evenly

> IDA(Initial Data Acceleration)

The eMMC prevents the pre-burned data from data-loss with IDA, in case of our customer had pre-burned data to eMMC, before the eMMC being SMT.

Cache

The eMMC enhanced the data written performance with Cache, with which our customer would get more endurance and reliability.



5. Product Specifications

5.1 Performance

| Density | Read | Write | Turbo Write(FBA) |
|---------|---------|--------|------------------|
| 32GB | 230MB/s | 32MB/s | Up to 130MB/s |

• Test Condition: Bus width x8, 200MHz DDR, 512KB data transfer, w/o file system overhead, measured on internal board

• Test tool: uBOOT (Without O/S)

· Chunk size: 1MB,

• Test area: 100MB/ Full-range of LBA.

5.2 Power Consumption

5.2.1 Active power consumption during operation

| Density | lcc | Iccq | | |
|---------|-------|-------|--|--|
| 32GB | 100mA | 100mA | | |

• Power Measurement conditions: Bus configuration =x8 @200MHz DDR, 25°C.

• Vcc:3.3V & Vccq: 1.8V.

• The measurement for max RMS current is the average RMS current consumption over a period of 100ms.

5.2.2 Low power mode (stand-by)

| Density | lcc | lccq | | |
|---------|------|-------|--|--|
| 32GB | 80uA | 100uA | | |

- Power Measurement conditions: Bus configuration =x8 @200MHz DDR, 25°C.
- Standby: Nand Vcc & Controller Vccq power supply is switched on.
- The measurement for max RMS current is the average RMS current consumption over a period of 100ms.

5.2.3 Low power mode (sleep)

| Density | lcc | lccq |
|---------|-----|-------|
| 32GB | 0 | 100uA |

- Power Measurement conditions: Bus configuration =x8 @200MHz DDR, 25° C.
- Sleep: Nand Vcc power supply is switched off(Controller Vccq on)
- The measurement for max RMS current is the average RMS current consumption over a period of 100ms.



6. Pin Assignments

6.1 Ball Array view

| | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | ٦ |
|---|------|--------|------|--------|------|--------|------|------|------|-------|------|------|------|------|---|
| A | NC | NC | DAT0 | DAT1 | DAT2 | Vss | RFU | NC | NC | NC | NC | NC | NC | NC | |
| В | NC | DAT3 | DAT4 | DAT5 | DAT6 | (DAT7) | (NC) | (NC) | (NC) | (NC) | (NC) | (NC) | NC | NC | |
| c | NC | (VDDi) | (NC) | Vssq | (NC) | Vccq | (NC) | (NC) | (NC) | (NC) | (NC) | NC | (NC) | NC | |
| D | (NC) | (NC) | (NC) | (NC) | | | | | | | | (NC) | (NC) | NC | |
| E | NC | (NC) | NC | | RFU | Vcc | Vss | VSF | VSF | VSF | | NC | NC | NC | |
| F | NC | NC | NC | | Vcc | | | | | VSF | | NC | NC | NC | |
| G | NC | NC | RFU | | Vss | | | | | VSF | | NC | NC | NC | |
| н | NC | NC | NC | | (DS) | | | | | Vss | | NC | NC | NC | |
| ı | NC | NC | NC | | vss | | | _ | | Vcc | | NC | NC | NC | |
| к | NC | NC | NC | | RSTN | RFU | RFU | Vss | Vcc | VSF | | NC | NC | NC | |
| L | (NC) | (NC) | (NC) | | | | | | | | | (NC) | (NC) | (NC) | |
| м | (NC) | (NC) | (NC) | (Vccq) | (MD) | (CTK) | (NC) | (NC) | (NC) | (NC) | (NC) | (NC) | (NC) | (NC) | |
| N | (NC) | (Vssq) | (NC) | Vccq | Vssq | (NC) | (NC) | (NC) | (NC) | (NC) | (NC) | (NC) | (NC) | (NC) | |
| Р | (NC) | (NC) | Vccq | Vssq | Vccq | (Vssq) | (NC) | (NC) | (NC) | (VSF) | (NC) | (NC) | (NC) | (NC) | |
| | | | | | | | | | | | | | | | |

FBGA153 - Ball Array (Top view(ball site down))



6.2 Ball Array view

| Signal | Description | | | | |
|-------------|--|--|--|--|--|
| CLOCK | Each cycle of the clock directs a transfer on the command line and on the data lines. | | | | |
| (CLK) | Each cycle of the clock directs a transfer on the command line and on the data lines. | | | | |
| | This signal is a bidirectional command channel used for device initialization and command | | | | |
| | transfer. | | | | |
| COMMAND | The CMD Signal has 2 operation modes: open drain, for initialization, and push-pull, for | | | | |
| (CMD) | command transfer. | | | | |
| | Commands are sent from the host to the device, and responses are sent from the device to | | | | |
| | the host. | | | | |
| | These are bidirectional data signal. The DAT signals operate in push-pull mode. | | | | |
| | By default, after power-up or RESET, only DAT0 is used for data transfer. The controller can | | | | |
| | configure a wider data bus for data transfer wither using DAT [3:0](4bit mode)or DAT[7:0](8bit | | | | |
| DATA | mode). | | | | |
| (DAT0-DAT7) | Includes internal pull-up resistors for data lines DAT[7:1].Immediately after entering the 4-bit | | | | |
| | mode, the device disconnects the internal pull-up resistors on the DAT1 and DAT2 lines.(The | | | | |
| | DAT3 line internal pull-up is left connected.)Upon entering the 8bit mode, the device | | | | |
| | disconnects the internal pull-up on the DAT1, DAT2, and DAT[7:4]lines. | | | | |
| Data Strobe | Newly assigned pin for HS400 mode. Data Strobe is generated from e.MMC to host. | | | | |
| (DS) | In HS400 mode, read data and CRC response are synchronized with Data Strobe. | | | | |
| RESET | Handurana Dagat lanut | | | | |
| (RSTN) | Hardware Reset Input | | | | |
| V | Vccq is the power supply line for host interface, have two power mode: High power | | | | |
| Vccq | mode:2.7V~3.6V; Lower power mode:1.7V~1.95V | | | | |
| Vcc | Vcc is the power supply line for internal flash memory, its power voltage range is:2.7V~3.6V | | | | |
| VDDi | VDDi is internal power node, not the power supply. Connect 1uF capacitor VDDi to ground | | | | |
| Vss,Vssq | Ground lines. | | | | |

Note:

NC: No Connect, shall be connected to ground or left floating.

RFU: Reserved for Future Use, must be left floating for future use.

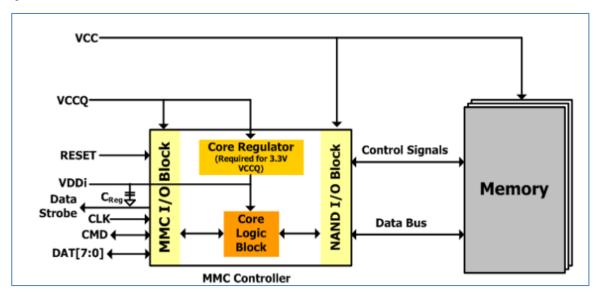
VSF: Vendor Specific Function, must be left floating.



7. Usage Overview

7.1 General description

The eMMC can be operated in 1, 4, or 8-bit mode. NAND flash memory is managed by a controller inside, which manages ECC, wear leveling and bad block management. The eMMC provides easy integration with the host process that all flash management hassles are invisible to the host.

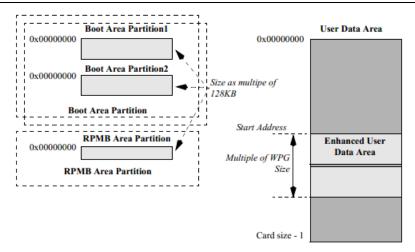


7.2 Partition Management

The embedded device offers also the possibility of configuring by the host additional split local memory partitions with independent addressable space starting from logical address 0x00000000 for different usage models. Default size of each Boot Area Partition is 4096 KB and can be changed by Vendor Command as multiple of 128KB. Boot area partition size is calculated as (128KB * BOOT_SIZE_MULTI) The size of Boot Area Partition 1 and 2 cannot be set independently and is set as same value Boot area partition which is enhanced partition. Therefore memory block area scan is classified as follows:

- > Factory configuration supplies boot partitions.
- > The RPMB partition is 4MB.
- The host is free to configure one segment in the User Data Area to be implemented as enhanced storage media, and to specify its starting location and size in terms of Write Protect Groups. The attributes of this Enhanced User Data Area can be programmed only once during the device life-cycle (one-time programmable).
- > Up to four General Purpose Area Partitions can be configured to store user data or sensitive data, or for other host usage models. The size of these partitions is a multiple of the write protect group. Size and attributes can be programmed once in device life-cycle (one-time programmable). Each of the General Purpose Area Partitions can be implemented with enhanced technological features.



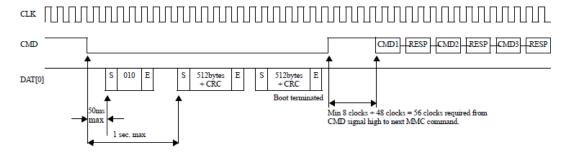


Partitions and user data area configuration

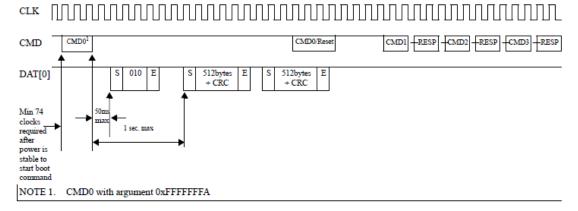
(The size of RPMB area partition is 4MB)

In boot operation mode, the master can read boot data from the slave (device) by keeping CMD line low or sending CMD0 with argument + 0xFFFFFFFA, before issuing CMD1. The data can be read from either boot area or user area depending on register setting.

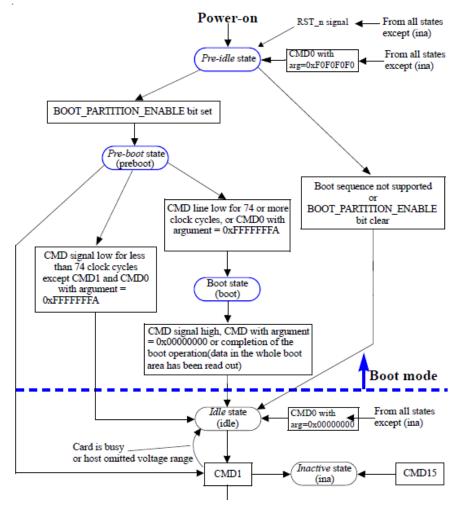
| Timing Factor | Value |
|---------------------|---------|
| Boot ACK Time | < 50 ms |
| Boot Data Time | <1s |
| Initialization Time | <1s |



State diagram (boot mode)



State diagram (alternative boot mode)



State diagram (boot mode)*

7.3 Automatic Sleep Mode

If host does not issue any command during certain duration (1s), after previously issued command is completed, the device enters "Power Saving mode" to reduce power consumption. At this time, commands arriving at the device while it is in power saving mode will be serviced in normal fashion. The below table explains the condition to enter and exit Auto Power Saving Mode

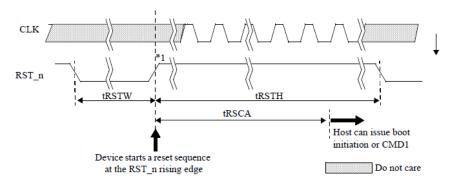
7.4 Sleep (CMD5)

A card may be switched between a Sleep state and a Standby state by SLEEP/AWAKE (CMD5). In the Sleep state the power consumption of the memory device is minimized. In this state the memory device reacts only to the commands RESET (CMD0 with argument of either 0x000000000 or 0xF0F0F0F0 or H/W reset) and SLEEP/AWAKE (CMD5). All the other commands are ignored by the memory device. The timeout for state transitions between Standby state and Sleep state is defined in the EXT_CSD register S_A_timeout. The maximum current consumptions during the Sleep state are defined in the EXT_CSD registers S_A_VCC and S_A_VCCQ. Sleep command: The bit 15 as set to 1 in SLEEP/ AWAKE (CMD5) argument. A wake command: The bit 15 as set to 0 in SLEEP/AWAKE (CMD5) argument.



7.5 H/W Reset operation

Device will detect the rising edge of RST_n signal to trigger internal reset sequence



H/W reset waveform

7.6 High-speed mode selection

After the host verifies that the card complies with version 4.0, or higher, of this standard, it has to enable the high speed mode timing in the card, before changing the clock frequency to a frequency higher than 20MHz. For the host to change to a higher clock frequency, it has to enable the high speed interface timing. The host uses the SWITCH command to write 0x01 to the HS_TIMING byte, in the Modes segment of the EXT_CSD register.

7.7 Bus width selection

After the host has verified the functional pins on the bus it should change the bus width configuration accordingly, using the SWITCH command. The bus width configuration is changed by writing to the BUS_WIDTH byte in the Modes Segment of the EXT_CSD register (using the SWITCH command to do so). After power-on, or software reset, the contents of the BUS_WIDTH byte is 0x00.

7.8 Partition configuration

| Model | Area/Partition | Size (GB) | Size (MB) | Size (Sector) | Size (Byte) | Size (Hex, Byte) |
|-------------|------------------|-----------|-----------|---------------|-------------|---------------------|
| | User | 28.91 | 29600 | 60620800 | 31037849600 | 73A000000 |
| FEMDNN032G- | Boot Partition 1 | - | 4 | 8192 | 4194304 | 400000 |
| 58A46 | Boot Partition 2 | - | 4 | 8192 | 4194304 | 400000 |
| | RPMB | - | 4 | 8192 | 4194304 | 400000 |

7.9 CID register

The Card Identification (CID) register is 128 bits wide. It contains the card identification information used during the card identification phase (protocol). Every individual flash or I/O card shall have an unique identification number. Every type of ROM cards (defined by content) shall have a unique identification number. The structure of the CID register is defined in the following sections.

| Name | Field | Width | CID-slice | CID Value | Remark |
|--------------------|-------|-------|-----------|-----------|--------|
| Manufacturer ID | MID | 8 | [127:120] | D6h | |
| Reserved | - | 6 | [119:114] | | |
| Card/BGA | CBX | 2 | [113:112] | 01h | BGA |
| OEM/Application ID | OID | 8 | [111:104] | 03h | |



| Name | Field | Width | CID-slice | CID Value | Remark |
|-----------------------|-------|-------|-----------|-------------------------|-----------|
| Product name | PNM | 48 | [103:56] | 35h 38h 41h 34h 36h 31h | 58A461 |
| Product revision | PRV | 8 | [55:48] | | |
| Product serial number | PSN | 32 | [47:16] | | Not Fixed |
| Manufacturing date | MDT | 8 | [15:8] | | Not Fixed |
| CRC7 checksum | CRC | 7 | [7:1] | | Not Fixed |
| Not used, always '1' | - | 1 | [0:0] | | |

7.10 CSD register

The Card-Specific Data (CSD) register provides information on how to access the card contents. The CSD defines the data format, error correction type, maximum data access time, data transfer speed, whether the DSR register can be used etc. The programmable part of the register (entries marked by W or E, see below) can be changed by CMD27. The type of the CSD Registry entries coded as follows:

| Name | Field | Width | Cell Type | CSD-slice |
|--|--------------------|-------|-----------|-----------|
| CSD structure | CSD_STRUCTURE | 2 | R | [127:126] |
| System specification version | SPEC_VERS | 4 | R | [125:122] |
| Reserved | - | 2 | R | [121:120] |
| Data read access-time 1 | TAAC | 8 | R | [119:112] |
| Data read access-time 2 in CLK cycles (NSAC*100) | NSAC | 8 | R | [111:104] |
| Max. bus clock frequency | TRAN_SPEED | 8 | R | [103:96] |
| Card command classes | CCC | 12 | R | [95:84] |
| Max. read data block length | READ_BL_LEN | 4 | R | [83:80] |
| Partial blocks for read allowed | READ_BL_PARTIAL | 1 | R | [79:79] |
| Write block misalignment | WRITE_BLK_MISALIGN | 1 | R | [78:78] |
| Read block misalignment | READ_BLK_MISALIGN | 1 | R | [77:77] |
| DSR implemented | DSR_IMP | 1 | R | [76:76] |
| Reserved | - | 2 | R | [75:74] |
| Device size | C_SIZE | 12 | R | [73:62] |
| Max. read current @ V _{DD} min | VDD_R_CURR_MIN | 3 | R | [61:59] |
| Max. read current @ V _{DD} max | VDD_R_CURR_MAX | 3 | R | [58:56] |
| Max. write current @ V _{DD} min | VDD_W_CURR_MIN | 3 | R | [55:53] |
| Max. write current @ V _{DD} max | VDD_W_CURR_MAX | 3 | R | [52:50] |
| Device size multiplier | C_SIZE_MULT | 3 | R | [49:47] |
| Erase group size | ERASE_GRP_SIZE | 5 | R | [46:42] |
| Erase group size multiplier | ERASE_GRP_MULT | 5 | R | [41:37] |
| Write protect group size | WP_GRP_SIZE | 5 | R | [36:32] |
| Write protect group enable | WP_GRP_MULT | 1 | R | [31:31] |
| Manufacturer default ECC | DEFAULT_ECC | 2 | R | [30:29] |
| Write speed factor | R2W_FACTOR | 3 | R | [28:26] |
| Max. write data block length | WRITE_BL_LEN | 4 | R | [25:22] |
| Partial blocks for write allowed | WRITE_BL_PARTIAL | 1 | R | [21:21] |
| Reserved | - | 4 | R | [20:17] |
| Content protection application | CONTENT_PROT_APP | 1 | R | [16:16] |



| Name | Field | Width | Cell Type | CSD-slice |
|----------------------------|--------------------|-------|-----------|-----------|
| File format group | FILE_FORMAT_GRP | 1 | R/W | [15:15] |
| Copy flag(OTP) | COPY | 1 | R/W | [14:14] |
| Permanent write protection | PERM_WRITE_PROTECT | 1 | R/W | [13:13] |
| Temporary write protection | TMP_WRITE_PROTECT | 1 | R/W/E | [12:12] |
| File format | FILE_FORMAT | 2 | R/W | [11:10] |
| ECC code | ECC | 2 | R/W/E | [9:8] |
| CRC | CRC | 7 | R/W/E | [7:1] |
| Not used, always '1' | - | 1 | - | [0:0] |

7.11 Extended CSD register

The Extended CSD register defines the card properties and selected modes. It is 512 bytes long. The most significant 320 bytes are the Properties segment, which defines the card capabilities and cannot be modified by the host. The lower 192 bytes are the Modes segment, which defines the configuration the card is working in. These modes can be changed by the host by means of the SWITCH command.

| Name | Field | Size | Туре | Slice [bytes] | Value | Description |
|---------------------------------------|------------------------|------|------|------------------|-------|------------------------|
| | Reserved | 6 | - | [511:506] | - | |
| Extended security error | EXT_SECURITU_ERR | 1 | R | [505] | 0 | |
| Supported Command Sets | S_CMD_SET | 1 | R | [504] | 1h | |
| HPI Features | HPI_FEATURES | 1 | R | [503] | 1h | |
| Background operations support | BKOPS_SUPPORT | 1 | R | [502] | 1h | BKOPS supported |
| Max packed read command | MAX_PACKED_READS | 1 | R | [501] | 3Fh | |
| Max packed write command | MAX_PACKED_WRITES | 1 | R | [500] | 3Fh | |
| Data Tag Support | DATA_TAD_SUPPORT | 1 | R | [499] | 1h | |
| Tag Unit Size | TAG_UNIT_SIZE | 1 | R | [498] | 3h | |
| Tag Resource Size | TAG_RES_SIZE | 1 | R | [497] | 0h | |
| Context management capabilities | CONTEXT_CAPABITILITIES | 1 | R | [496] | 5h | |
| Large Unit size | LARGE_UNIT_SIZE_M1 | 1 | R | [495] | 7h | Large Unit size 8MB |
| Extended partitions attribute support | EXT_SUPPORT | 1 | R | [494] | 3h | |
| Supported modes | SUPPORTED_MODES | 1 | R | [493] | 3h | |





| | | | | Slice | | |
|---|-----------------------------------|------|------|-----------|--------|--|
| Name | Field | Size | Туре | [bytes] | Value | Description |
| FFU features | FFU_FEATURES | 1 | R | [492] | 0h | |
| Operation codes timeout | OPERATION_CODE_TIMEOU T | 1 | R | [491] | 0h | |
| FFU Argument | FFU_ARG | 4 | R | [490:487] | 0h | |
| Barrier support | BARRIER_SUPPORT | 1 | R | [486] | 0h | |
| | Reserved | 177 | - | [485:309] | - | |
| CMDQ support | CMDQ_SUPPORT | 1 | W/R | [308] | 1h | |
| CMDQ depth | CMDQ_DEPTH | 1 | W/R | [307] | 1Fh | |
| | Reserved | 1 | - | [306] | - | |
| Number of received sectors | NUMBER_OF_RECEIVED_SEC TORS | 4 | R | [305:302] | 0h | |
| Vendor proprietary health report | VENDOR_PROPRIETARY_HEA LTH_REPORT | 1 | R | [301:270] | 0h | |
| Device life time estimation type B | DEVICE_LIFE_TIME_EST_TYP _B | 1 | R | [269] | 1h | |
| Device life time estimation type A | DEVICE_LIFE_TIME_EST_TYP _A | 1 | R | [268] | 1h | |
| Pre EOL information | PRE_EOL_INFO | 1 | R | [267] | 1h | |
| Optimal read size | OPTIMAL_READ_SIZE | 1 | R | [266] | 0h | |
| Optimal write size | OPTIMAL_WRITE _SIZE | 1 | R | [265] | 20h | |
| Optimal trim unit size | OPTIMAL_TRIM_UNIT_SIZE | 1 | R | [264] | 1h | |
| Device version | DEVICE_VERSION | 2 | R | [263:262] | 0h | |
| Firmware version | FIRMWARE_VERSION | 8 | R | [261:254] | - | FW Patch Ver. |
| Power class for200MHz,DDR at VCC=3.6V | PWR_CL_DDR_200_360 | 1 | R | [253] | 0h | |
| Cache size | CACHE_SIZE | 4 | R | [252:249] | 10000h | |
| Generic CMD6 timeout | GENERIC_CMD6_TIME | 1 | R | [248] | Ah | Generic CMD6 timeout 100ms |
| Power-off notification(long) timeout | POWER_OFF_LONG_TIME | 1 | R | [247] | 3Ch | Power off notification(long) timeout 600ms |
| Background operations status | BKOPS_STATUS | 1 | R | [246] | 0h | No operations required |





Rev. 1.0 FEMDNN032G-58A46

| Name | Field | Size | Туре | Slice [bytes] | Value | Description | |
|----------------------|------------------------------|------|------|------------------|-------|---------------------|--|
| Number of | | | | | | | |
| correctly | CORRECTLY_PRG_SECTORS_ | 4 | R | [0.45:0.40] | 0h | | |
| programmed | NUM | 4 | ĸ | [245:242] | UII | | |
| sectors | | | | | | | |
| First Initialization | | | | | | | |
| time after | INI_TIMEOUT_AP | 1 | R | [241] | 1Eh | initial time out 3s | |
| partitioning | | | | | | | |
| Cache Flushing | CACHE FILIELI DOLICY | 1 | R | [0.40] | 0h | | |
| Policy | CACHE_FLUSH_POLICY | ı | К | [240] | un | | |
| Power class for | | | | | | 100 A l | |
| 52Mhz,DDR at | PWR_CL_DDR_52_360 | 1 | R | [239] | 0h | rms 100 mA, peak | |
| 3.6V | | | | | | 200 mA | |
| Power class for | | | | | | rms 65 mA, peak | |
| 52Mhz,DDR at | PWR_CL_DDR_52_195 | 1 | R | [238] | 0h | 130 mA | |
| 1.95V | | | | | | 130 IIIA | |
| Power class for | | | | | | | |
| 200Mhz at | PWR_CL_200_195 | 1 | R | [237] | 0h | | |
| VCCQ=1.95V, | PWR_CL_200_195 | ı | ĸ | [237] | UII | | |
| VCC=3.6V | | | | | | | |
| Power class for | | | | | | | |
| 200Mhz at | PWR_CL_200_360 | 1 | R | [236] | 0h | | |
| VCCQ=1.3V, | FWR_CL_200_300 | Į | IV. | [230] | OII | | |
| VCC=3.6V | | | | | | | |
| Minimum write | | | | | | For cards not | |
| performance for | MIN_PERF_DDR_W_8_52 | 1 | R | [235] | 0h | reaching the 4.8 | |
| 8bit at 52MHz in | WINT LIN DDI W O O | ' | 1 | [233] | OII | MB/s value | |
| DDR mode | | | | | | Only support SDR | |
| Minimum read | | | | | | For cards not | |
| performance for | MIN_PERF_DDR_R_8_52 | 1 | R | [234] | 0h | reaching the | |
| 8bit at 52MHz in | MIN _ EN _ DDI _ N _ 0_02 | ' | 1 | [207] | OII | 4.8MB/s value | |
| DDR mode | | | | | | | |
| | Reserved | 1 | - | [233] | - | | |
| TRIM Multiplier | TRIM_MULT | 1 | R | [232] | 5h | trim time out 1.5s | |



Rev. 1.0 FEMDNN032G-58A46

| Name | Field | Size | Туре | Slice [bytes] | Value | Description |
|--|---------------------|------|------|------------------|-------|---|
| Secure feature support | SEC_FEATURE_SUPPORT | 1 | R | [231] | 55h | 1. Support the secure and insecure trim operations. 2. Support the automatic secure purge operation on retired defective portions of the array. 3. Secure purge operations are supported. 4. Support the sanitize operation |
| Secure Erase Multiplier | SEC_ERASE_MULT | 1 | R | [230] | 1Bh | secure erase time out 40.5s |
| Secure TRIM Multiplier | SEC_TRIM_MULT | 1 | R | [229] | 11h | secure trim time out 25.5s |
| Boot Information | BOOT_INFO | 1 | R | [228] | 7h | Support high speed timing boot. Support dual data rate during boot Support alternative boot method |
| | Reserved | 1 | - | [227] | - | |
| Boot partition size | BOOT_SIZE_MULTI | 1 | R | [226] | 20h | boot partition 4096KB |
| Access size | ACC_SIZE | 1 | R | [225] | 6h | super page 16KB |
| High-capacity Erase unit size | HC_ERASE_GROUP_SIZE | 1 | R | [224] | 1h | hc erase group size 512KB |
| High-capacity Erase time out | ERASE_TIMEOU_MULT | 1 | R | [223] | 5h | hc erase time out |
| Reliable write sector count | REL_WR_SEC_C | 1 | R | [222] | 1h | 1 sector |
| High-capacity write protect group size | HC_WP_GRP_SIZE | 1 | R | [221] | 8h | hc wp group size 4096KB |





| | | | | | FEMDINIO329 | | |
|--|-------------------------------------|------|------|------------------|-------------|--|--|
| Name | Field | Size | Туре | Slice [bytes] | Value | Description | |
| Sleep current(VCC) | s_c_vcc | 1 | R | [220] | 7h | 128µA | |
| Sleep current[VCCQ] | s_c_vccq | 1 | R | [219] | 7h | 128μΑ | |
| Production state awareness timeout | PRODUCTION_STATE_AWA RENESS_TIMEOUT | 1 | R | [218] | 0h | Not defined | |
| Sleep/Awake time out | S_A_TIMEOUT | 1 | R | [217] | 16h | Sleep/Awake timeout 419.43ms | |
| Sleep Notification Time out | SLEEP_NOTIFICATION_TIM E | 1 | R | [216] | 10h | Sleep Notification Time out 655.36ms | |
| Sector count | SEC_COUNT | 4 | R | [215:212] | - | | |
| Secure Write Protection Mode | SECURE_WP_INFO | 1 | | [211] | 1h | | |
| Minimum Write Performance for 8bit @52MHz | MIN_PERF_W_8_52 | 1 | R | [210] | 0h | | |
| Minimum Read Performance for 8bit @52MHz | MIN_PERF_R_8_52 | 1 | R | [209] | Oh | | |
| Minimum Write Performance for 4bit @52MHz or 8bit @26MHz | MIN_PERF_W_8_26_4_52 | 1 | R | [208] | Oh | | |
| Minimum Read Performance for 4bit @52MHz or 8bit @26MHz | MIN_PERF_R_8_26_4_52 | 1 | R | [207] | Oh | | |
| Minimum Write Performance for 4bit @26MHz | MIN_PERF_W_4_26 | 1 | R | [206] | 0h | | |
| Minimum Read Performance for 4bit @26MHz | MIN_PERF_R_4_26 | 1 | R | [205] | 0h | | |
| | Reserved | 1 | - | [204] | - | | |
| Power Class for 26MHz @3.6V | PWR_CL_26_360 | 1 | R | [203] | 0h | rms 100 mA, peak 200 mA | |
| Power Class for 52MHz @3.6V | PWR_CL_52_360 | 1 | R | [202] | 0h | rms 100 mA, peak 200 mA | |



Rev. 1.0 FEMDNN032G-58A46

| | | | | Slice | | |
|---------------------------------|-----------------------|------|------------------|---------|-------|---------------------------------|
| Name | Field | Size | Туре | [bytes] | Value | Description |
| Power Class for 26MHz @1.95V | PWR_CL_26_195 | 1 | R | [201] | 0h | rms 65 mA, peak 130 mA |
| Power Class for 52MHz @1.95V | PWR_CL_52_195 | 1 | R | [200] | 0h | rms 65 mA, peak 130 mA |
| Partition switching timing | PARTITION_SWITCH_TIME | 1 | R | [199] | Ah | Partition switch time out 100ms |
| Out-of-interrupt busy timing | OUT_OF_INTERRUPT_TIME | 1 | R | [198] | 5h | HPI time out 50ms |
| I/O Driver Strength | DRIVER_STRENGTH | 1 | R | [197] | 1Fh | |
| Card Type | CARD_TYPE | 1 | R | [196] | 57h | |
| | Reserved | 1 | - | [195] | - | |
| CSD Structure Version | CSD_STRUCTURE | 1 | R | [194] | 2h | CSD version No. |
| | Reserved | 1 | - | [193] | - | |
| Extended CSD Revision | EXT_CSD_REV | 1 | R | [192] | 8h | Revision 1.8 (for MMC v5. 1) |
| Command Set | CMD_SET | 1 | R/W/E_P | [191] | 0h | |
| | Reserved | 1 | - | [190] | - | |
| Command set revision | CMD_SET_REV | 1 | R | [189] | 0h | |
| | Reserved | 1 | - | [188] | - | |
| Power class | POWER_CLASS | 1 | R/W/E_P | [187] | 0h | |
| | Reserved | 1 | - | [186] | - | |
| High Speed Interface Timing | HS_TIMING | 1 | R/W/E_P | [185] | 0h | |
| Strobe Support | STROBE_SUPPORT | 1 | R | [184] | 1h | |
| Bus Width Mode | BUS_WIDTH | 1 | W/E_P | [183] | 0h | |
| | Reserved | 1 | - | [182] | - | |
| Erased memory range | ERASE_MEM_CONT | 1 | R | [181] | 0h | |
| | Reserved | 1 | - | [180] | - | |
| Partition Configuration | PARTITION_CONFIG | 1 | R/W/E R/W/E_P | [179] | 0h | |
| Boot config protection | BOOT_CONFIG_PROT | 1 | R/W R/W/C_P | [178] | Oh | |
| Boot bus width1 | BOOT_BUS_WIDTH | 1 | R/W/E | [177] | 0h | |
| | Reserved | 1 | - | [176] | - | |





| Name | Field | Size | Туре | Slice [bytes] | Value | Description | |
|---|-----------------|------|---------------------------|------------------|-------|---|--|
| High-density erase group definition | ERASE_GROUP_DEF | 1 | R/W/E_P | [175] | 0h | | |
| Boot write protection status registers | BOOT_WP_STATUS | 1 | R | [174] | 0h | | |
| Boot area write protect register | BOOT_WP | 1 | R/W R/W/C_P | [173] | 0h | | |
| | Reserved | 1 | - | [172] | - | | |
| User area write protect register | USER_WP | 1 | R/W R/W/C_P R/W/E_P | [171] | 0h | | |
| | Reserved | 1 | - | [170] | - | | |
| FW Configuration | FW_CONFIG | 1 | R/W | [169] | 0h | | |
| RPMB Size | RPMB_SIZE_MULT | 1 | R | [168] | 20h | RPMB size is 4MB | |
| Write reliability setting register | WR_REL_SET | 1 | R/W | [167] | 1Fh | | |
| Write reliability parameter register | WR_REL_PARAM | 1 | R | [166] | 15h | Support the enhanced definition of reliable write | |
| Start Sanitize operation | SANITIZE_START | 1 | W/E_P | [165] | 0h | | |
| Manually start background operations | BKOPS_START | 1 | W/E_P | [164] | 0h | | |
| Enable background operations handshake | BKOPS_EN | 1 | R/W | [163] | 0h | | |
| H/W reset function | RST_n_FUNCTION | 1 | R/W | [162] | 0h | | |
| HPI management | HPI_MGMT | 1 | R/W/E_P | [161] | 0h | | |





| | | | | Slice | | | |
|---|--------------------------------|------|------------------------------------|-----------|-------|---|--|
| Name | Field | Size | Туре | [bytes] | Value | Description | |
| Partitioning support | PARTITIONING_SUPPORT | 1 | R | [160] | 7h | 1. Enhanced technological features in partitions and user data area. 2. Device supports partitioning features 3. Device can have extended partition attribute | |
| Max Enhanced Area Size | MAX_ENH_SIZE_MULT | 3 | R | [159:157] | 100h | | |
| Partitions attribute | PARTITIONS_ATTRIBUTE | 1 | R/W | [156] | 0h | | |
| Partitions setting | PARTITIONS_SETTING_CO MPLETED | 1 | R/W | [155] | 0h | | |
| General Purpose Partition Size | GP_SIZE_MULT | 12 | R/W | [154:143] | 0h | | |
| Enhanced User Data Area Size | ENH_SIZE_MULT | 3 | R/W | [142:140] | 0h | | |
| Enhanced User Data Start Address | ENH_START_ADDR | 4 | R/W | [139:136] | Oh | | |
| _ | Reserved | 1 | - | [135] | - | | |
| Secure Bad Block Management Mode | SEC_BAD_BLK_MGMNT | 1 | R/W | [134] | Oh | | |
| Production state awareness | PRODUCTION_STATE_ AWARENESS | 1 | R/W/E | [133] | 0h | | |
| Package Case Temperature is controlled | TCASE_SUPPORT | 1 | W/E_P | [132] | 0h | | |
| Periodic Wake-up | PERIODIC_WAKEUP | 1 | R/W/E | [131] | 0h | | |
| Program CID/CSD in DDR mode support | PROGRAM_CID_CSD_DDR_S UPPORT | 1 | R | [130] | 1h | | |
| | Reserved | 2 | - | [129:128] | - | | |
| Vendor specific field | VENDOR_SPECIFIC_FIELD | 64 | <vendor specfic></vendor | [127:64] | 0h | | |
| Native sector size | NATIVE_SECTOR_SIZE | 1 | R | [63] | 0h | | |



| Name | Field | Size | Туре | Slice | Value | Description |
|---|----------------------------|------|---------|---------|-------|-------------|
| Ocatomaia | | | | [bytes] | | |
| Sector size emulation | USE_NATIVE_SECTOR | 1 | R/W | [62] | 0h | |
| Sector size | DATA_SECTOR_SIZE | 1 | R | [61] | 0h | |
| 1st initialization after disabling sector size emulation | INI_TIMEOUT_EMU | 1 | R | [60] | 0h | |
| Class 6 commands control | CLASS_6_CTRL | 1 | R/W/E_P | [59] | 0h | |
| Number of addressed group to be Released | DYNCAP_NEEDED | 1 | R | [58] | 0h | |
| Exception events control | EXCEPTION_EVENTS_CTRL | 2 | R/W/E_P | [57:56] | 0h | |
| Exception events status | EXCEPTION_EVENTS_STAT US | 2 | R | [55:54] | 0h | |
| Extended Partitions Attribute | EXT_PARTITIONS_ATTRIBU TE | 2 | R/W | [53:52] | 0h | |
| Context configuration | CONTEXT_CONF | 15 | R/W/E_P | [51:37] | 0h | |
| Packed command status | PACKED_COMMAND_STAT | 1 | R | [36] | 0h | |
| Packed command failure index | PACKED_FAILURE_INDEX | 1 | R | [35] | 0h | |
| Power Off Notification | POWER_OFF_NOTIFICATIO N | 1 | R/W/E_P | [34] | 0h | |
| Control to turn the Cache ON/OFF | ON/OFF CACHE_CTRL | 1 | R/W/E_P | [33] | 0h | |
| Flushing of the cache | FLUSH_CACHE | 1 | W/E_P | [32] | 0h | |
| Control to turn the Barrier ON/OFF | ON/OFF BARRIER_CTRL | 1 | R/W | [31] | 0h | |
| Mode config | MODE_CONFIG | 1 | R/W/E_P | [30] | 0h | |
| Mode operation codes | MODE_OPERATION_CODES | 1 | W/E_P | [29] | 0h | |
| | Reserved | 2 | - | [28:27] | - | |
| FFU status | FFU_STATUS | 1 | R | [26] | 0h | |



| Name | Field | Size | Туре | Slice [bytes] | Value | Description |
|--|-------------------------------------|------|---------|------------------|-------|-------------|
| Pre loading data size | PRE_LOADING_DATA_SIZE | 4 | R/W/E_P | [25:22] | 0h | |
| Max pre loading data size | MAX_PRE_LOADING_DATA_ SIZE | 4 | R | [21:18] | - | |
| Product state awareness enablement | PRODUCT_STATE_AWAREN ESS_ENABLEMENT | 1 | R/W/E&R | [17] | 0h | |
| Secure Removal Type | SECURE_REMOVAL_TYPE | 1 | R/W&R | [16] | 9h | |
| Command Queue Mode Enable | CMDQ_MODE_EN | 1 | R/W/E_P | [15] | 0h | |
| | Reserved | 15 | - | [14:0] | - | |

Notes:

R= Read-only

R/W=One-Time Programmable and readable

R/W/E=Multiple writable with value kept after a power cycle, assertion of the RST_n signal, and any CMD0 reset, and readable

TBD=To Be Defined.

2. Reserved bits should be read as 0.

7.12 OCR Register

The 32-bit operation conditions register stores the VCCQ voltage profile of the eMMC. In addition, this register includes a status information bit. This status bit is set if the eMMC power up procedure has been finished. The OCR register shall be implemented by eMMC.

| OCR bit | VCCQ voltage window | еММС |
|---------|-----------------------------|-----------------------------------|
| [6:0] | Reserved | 000 0000Ь |
| [7] | 1.7-1.95 | 1b |
| [14:8] | 2.0-2.6 | 000 0000b |
| [23:15] | 2.7-3.6 | 1 1111 1111b |
| [28:24] | Reserved | 000 0000Ь |
| [30:29] | Access Mode | 00b (byte mode)/10b (sector mode) |
| [31] | power up status bit (busy)* | |

Note*: This bit is set to LOW if the eMMC has not finished the power up routine. The supported voltage range is coded as shown in table.

7.13 Field firmware update(FFU)

To download a new firmware, the controller requires instruction sequence following JEDEC standard.

Longsys eMMC only supports Manual mode (MODE_OPERATION_CODES is not supported). For more details, refer to the App note.

Longsys eMMC (NCEMAD9D-xxG) Field F/W update flow - CMD sequence

| Operation | CMD | Remark |
|-----------------------|------------------------|--------|
| Set block length 512B | CMD16, arg: 0x00000200 | |



| Enter FFU mode | CMD6, arg: 0x031E0100 | | |
|------------------------|-------------------------|--|--|
| Send FW to | CMD2E ara : 0v00000000 | Sending CMD25 is followed by sending FW data ,The | |
| device(Download) | CMD25, arg : 0x00000000 | whole data should be sent by one or multi CMD25 | |
| CMD12: Stop | CMD12, arg: 0x00000000 | | |
| CMD6 : Exit FFU mode | CMD6, arg: 0x031E0000 | | |
| | | Check EXT_CSD[26] : FFU_SUCCESS | |
| Get EXT_CSD | CMD8,arg: 0x 0 | If FFU_SUCCESS is 0, FFU is succeeded, otherwise FFU | |
| | | is failed. | |
| Reset | HW Reset/Power | | |
| Reset | cycle/CMD0 | | |
| Re-Init to trans state | CMD0, CMD1 | | |
| | | Check EXT_CSD[26] : FFU_SUCCESS | |
| | | If FFU_SUCCESS is 0, FFU is succeeded, otherwise FFU | |
| Check FW Version | CMD8, arg: 0x00000000 | is failed. | |
| | | Do not verify data with CMD17/CMD18 while FFU | |
| | | mode. | |

SUPPORTED_MODE[493] (Read Only)

BIT[0]: '0' FFU is not supported by the device.

'1' FFU is supported by the device.

BIT[1]: '0' Vendor specific mode (VSM) is not supported by the device.

'1' Vendor specific mode is supported by the device.

| Bit | Field | Supportability |
|----------|----------|----------------|
| Bit[7:2] | Reserved | - |
| Bit[1] | VSM | Not support |
| Bit[0] | FFU | Support |

FFU_FEATURE[492] (Read Only)

BIT[0]: '0' Device does not support MODE_OPERATION_CODES field (Manual mode)

'1' Device supports MODE_OPERATION_CODES field (Auto mode)

| Bit | Field | Supportability |
|----------|--------------------------------|----------------|
| Bit[7:1] | Reserved | - |
| Bit[0] | SUPPORTED_MODE_OPERATION_CODES | Not support |

FFU_ARG[490-487] (Read Only)

Using this field the device reports to the host which value the host should set as an argument for read and write commands in FFU mode.

FW_CONFIG[169] (R/W)

BIT[0]: Update disable

0x0: FW updates enabled.

0x1: FW update disabled permanently

| | Bit | Field | Supportability |
|--|-----|-------|----------------|
|--|-----|-------|----------------|



| Bit[7:1] | Reserved | - |
|----------|----------------|--------------------------|
| Bit[0] | Update disable | FW updates enabled (0x0) |

FFU_STATUS[26] (R/W/E_P)

Using this field the device reports to the host the state of FFU process

| Value | Description |
|-------------|-------------------------------|
| 0x13 ~ 0xFF | Reserved |
| 0x12 | Error in downloading Firmware |
| 0x11 | Firmware install error |
| 0x10 | General error |
| 0x01 ~ 0x0F | Reserved |
| 0x00 | Success |

OPERATION_CODES_TIMEOUT[491](Read Only)

Maximum timeout for the SWITCH command when setting a value to the MODE_OPERATION_CODES field. The register is set to '0', because the controller doesn't support MODE_OPERATION_CODES.

| Value | Description | Timeout value |
|-------------|--|---------------|
| 0x01 ~ 0x17 | MODE_OPERATION_CODES_TIMEOUT = 100us x | (Not defined) |
| | 20PERATION_CODES_TIMEOUT | |
| 0x18 ~ 0xFF | Reserved | - |

MODE_OPERATION_CODES[29] (W/E_P)

The host sets the operation to be performed at the selected mode, in case MODE_CONFIGS is set to FFU_MODE,MODE_OPERATION_CODES could have the following values:

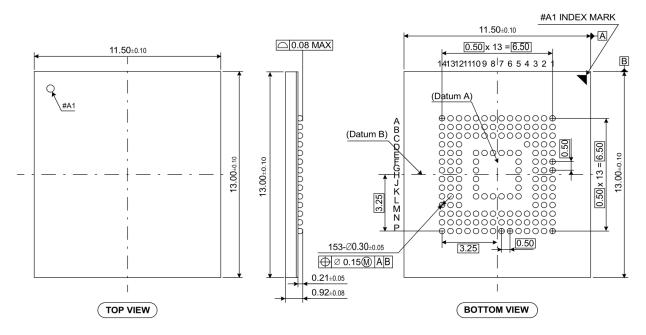
| Value | Description |
|--------------|-------------|
| 0x01 | FFU_INSTALL |
| 0x02 | FFU_ABORT |
| 0x00, others | Reserved |

7.14 S.M.A.R.T. Health Report

S.M.A.R.T. is a monitoring system that detects and reports on various indicators of eMMC reliability(Including original bad blocks, increased bad blocks, power-up number, power-loss counts and etc), with the intent of enabling the anticipation of hardware failures. We may be able to use recorded S.M.A.R.T. data to discover where the faults lie, ensure how to solve the problems and prevent them from recurring in future eMMC designs (For details, please refer to app note).



8. Package Dimension

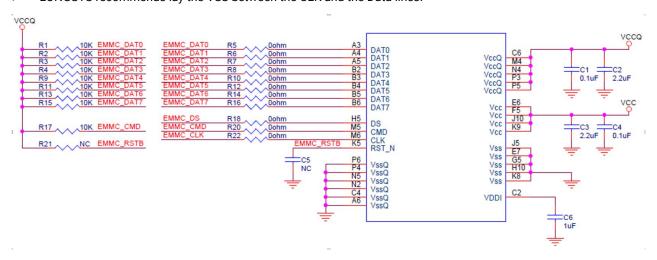


11.5mm x 13.0mm x 1.0mm Package Dimension

9 Connection Guide

9.1 Schematic Diagram

- Coupling capacitor should be connected with VCC/VCCQ and VSS as closely as possible.
- The resistance on the CLK line is highly recommended (0Ω by default). $0\Omega \sim 100\Omega$ is also available.
- ▶ LONGSYS recommends to separate VCC and VCCQ power.
- VDDi Capacitor is min 0.1uF.
- LONGSYS recommends lay the VSS between the CLK and the Data lines.



The resistance on the CLK line is highly recommended (0 Ω by default)



10. Processing Guide

It is recommended to follow the instructions of Moisture Sensitivity Level 3.

In the case of Pre-program before SMT, It is highly recommended to limit the size of data pre-programmed to the eMMC, please contact your agency for more information.

- > The amount of data pre-programmed (data written before SMT) is limited, it should be managed properly.
- Maximum size for the data-written to IDA.

| Part Number | Size limited for Pre-programmed Data |
|------------------|--------------------------------------|
| FEMDNN032G-58A46 | 9.5GB |